NSEMI.

IGBT - Ultra Field Stop 1200 V, 60 A FGY60T120SQDN

General Description

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Ultra Field Stop Trench construction, and provides superior performance in demanding switching applications, offering both low on-state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

Features

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature $T_J = 175^{\circ}C$
- Low Saturation Voltage: $V_{CE(sat)} = 1.7 \text{ V} (Typ.) @ I_C = 60 \text{ A}$
- 100% of the Parts Tested for I_{LM} (Note 1)
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- RoHS Compliant

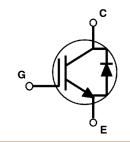
Applications

• Solar Inverter, UPS

ABSOLU	TE MAXIMUM RATINGS (T _A = 25°C un	less otherwise	noted)
Symbol	Description	Value	Unit
V _{CES}	Collector to Emitter Voltage	1200	V
V _{GES}	Gate to Emitter Voltage	±25	V
	Transient Gate to Emitter Voltage	±30	V
Ι _C	Collector Current @ (T _C = 25°C)	120	Α
	Collector Current @ (T _C = 100°C)	60	Α
I _{LM} (1)	Pulsed Collector Current @ (T _C = 25°C)	240	Α
I _{CM} (2)	Pulsed Collector Current	240	Α
١ _F	Diode Forward Current @ (T _C = 25°C)	120	А
	Diode Forward Current @ (T _C =100°C)	60	Α
I _{FM}	Pulsed Diode Max. Forward Current	240	А
PD	Maximum Power Dissipation	F17	W
	@ (T _C = 25°C) @ (T _C =100°C)	517 259	W
TJ	Operating Junction Temperature	–55 to +175	°C
T _{stg}	Storage Temperature Range	–55 to +175	°C
ΤL	Maximum Lead Temp. For soldering Purposes, 1/8" from case for 5 seconds	300	°C
0.	acading these listed in the Maximum Dating		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. VCC = 800 V, V_{GE} = 15 V, I_C = 240 A, R_G = 68 Ω , Inductive Load 2. Repetitive rating: Pulse width limited by max. Junction temperature





MARKING DIAGRAM



&Y = onsemi Logo &З = Data Code (Year & Week)

&K = Lot

FGY60T120SQDN= Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

THERMAL CHARACTERISTICS

Symbol	Parameter	FGY60T120SQDN	Unit
R _{θJC} (IGBT)	Thermal Resistance, Junction to Case, Max.	0.29	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	0.42	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25° C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARA	ACTERISTICS		•	•		
BV _{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0V, I_C = 500 μ A	1200	-	-	V
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	400	μA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±200	nA
ON CHARAC	CTERISTICS					
V _{GE(th)}	G-E Threshold Voltage	I_C = 400 μ A, V_{CE} = V_{GE}	4.5	5.5	6.5	V
		I _C = 60 A _, V _{GE} = 15 V	-	1.7	1.95	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{C} = 60 \text{ A}, \text{ V}_{GE} = 15 \text{ V}, \text{ T}_{C} = 175^{\circ}\text{C}$	-	2.3	-	v
	HARACTERISTICS		+	•		1
C _{ies}	Input Capacitance		-	7147	-	pF
Coes	Output Capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	-	203	-	pF
C _{res}	Reverse Transfer Capacitance		-	114	-	pF
SWITCHING	CHARACTERISTICS					
t _{d(on)}	Turn-On Delay Time		-	52	-	ns
tr	Rise Time	V_{CC} = 600 V, I _C = 60 A, R _G = 10 Ω, V_{GE} = 15 V, Inductive Load, T _C = 25°C	-	84	-	ns
td(off)	Turn-Off Delay Time		-	296	-	ns
t _f	Fall Time		-	56	-	ns
Eon	Turn-On Switching Loss		-	5.15	-	mJ
Eoff	Turn–Off Switching Loss		-	1.82	-	mJ
Ets	Total Switching Loss		-	6.97	-	mJ
td(on)	Turn-On Delay Time		-	40	-	ns
tr	Rise Time	V_{CC} = 600 V, I _C = 60 A, R _G = 10 Ω,	-	72	-	ns
td(off)	Turn-Off Delay Time	V _{GE} = 15 V,	-	324	-	ns
t _f	Fall Time	Inductive Load, T _C = 175°C	-	144	-	ns
Eon	Turn-On Switching Loss		-	7.18	-	mJ
Eoff	Turn-Off Switching Loss		-	3.1	-	mJ
Ets	Total Switching Loss		-	10.28	-	mJ
Qg	Total Gate Charge		-	311	-	nC
Qge	Gate to Emitter Charge	V_{CE} = 600 V, I_{C} = 60 A, V_{GE} = 15 V	-	57	-	nC
Qgc	Gate to Collector Charge		_	153	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_C = 25° C unless otherwise noted)

Symbol	Parameter	Test Condition		Min.	Тур.	Max.	Unit
V _{FM}			T _C = 25°C	-	3.4	4	
	Diode Forward Voltage		T _C = 175°C	-	3.2	-	V
	Diode Reverse Recovery Time	I _F = 60 A	T _C = 25°C	-	91	-	ns
t _{rr}			T _C = 175°C	-	309	_	
Q _{rr}	Diada Davaraa Daaayaan Ohaaraa		T _C = 25°C	_	860	_	nC
-11	Diode Reverse Recovery Charge		T _C = 175°C	-	4902	-	
I _{rrm}	Diode Reverse Recovery Current		T _C = 25°C	_	19	-	А
-000			T _C = 175°C	-	32	-	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Quantity
FGY60T120SQDN	FGY60T120SQDN	TO-247-3LD (Pb-Free)	30/Tube

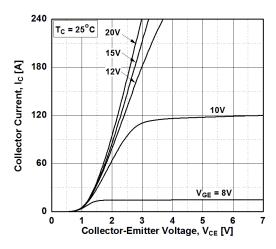


Figure 1. Typical Output Characteristics

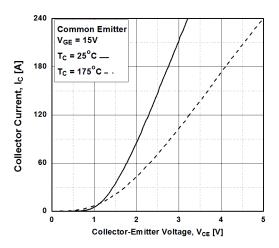


Figure 3. Typical Saturation Voltage Characteristics

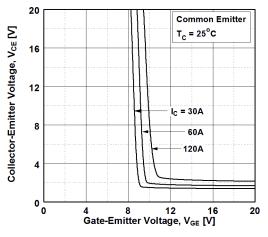


Figure 5. Saturation Voltage vs. V_{GE}

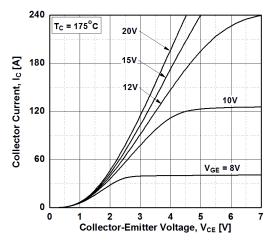


Figure 2. Typical Output Characteristics

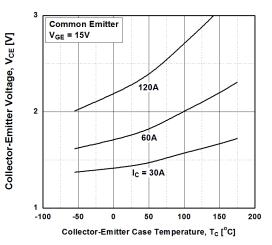


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

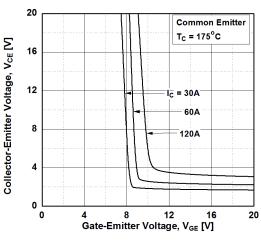
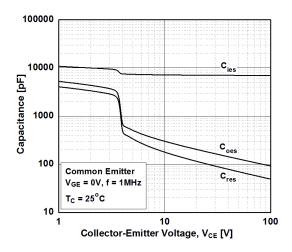


Figure 6. Saturation Voltage vs. V_{GE}





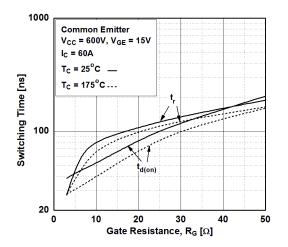


Figure 9. Turn-on Characteristics vs. Gate Resistance

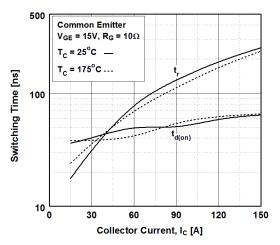


Figure 11. Turn-on Characteristics vs. Collector Current

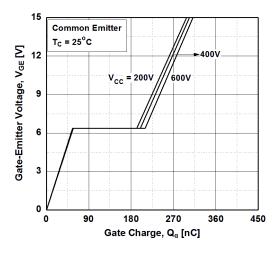


Figure 8. Gate charge Characteristics

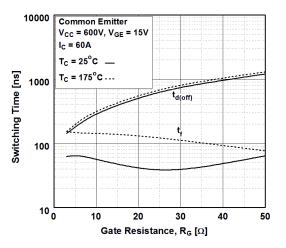


Figure 10. Turn-off Characteristics vs. Gate Resistance

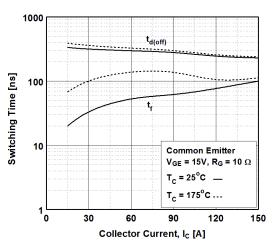
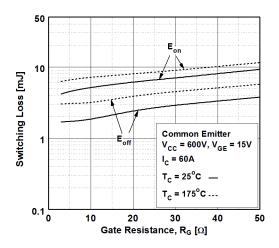
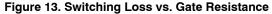


Figure 12. Turn-off Characteristics vs. Collector Current





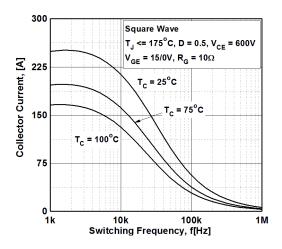


Figure 15. Load Current vs. Frequency

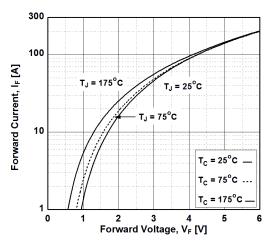


Figure 17. Forward Characteristics

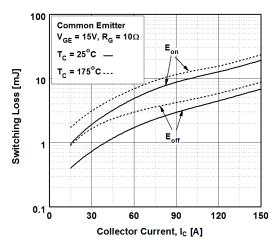
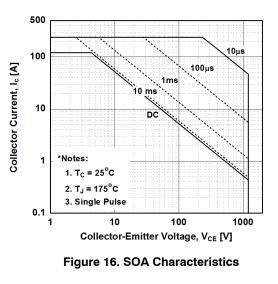
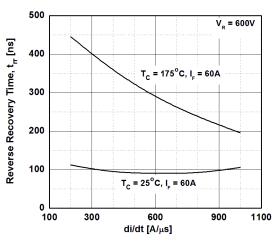


Figure 14. Switching Loss vs. Collector Current







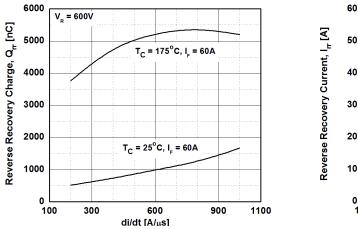


Figure 19. Reverse Recovery Charge vs. di_F/dt

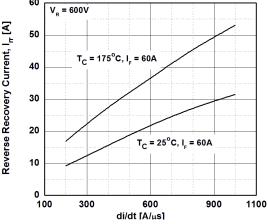


Figure 20. Reverse Recovery Current vs. di_F/dt

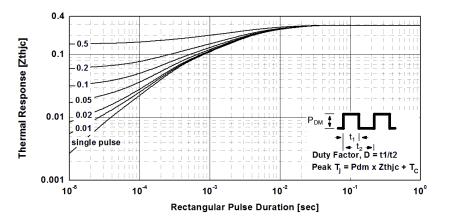


Figure 21. Transient Thermal Impedance if IGBT

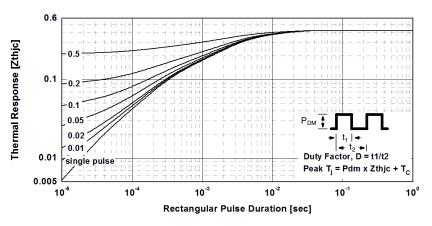
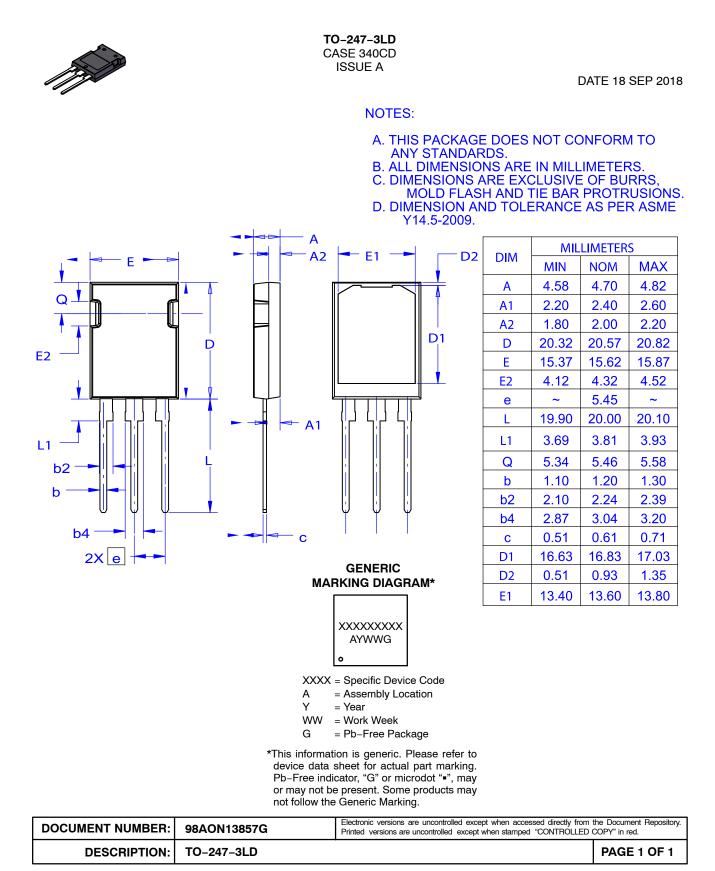


Figure 22. Transient Thermal Impedance if Diode





onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves
the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular
the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>